

Micropower, 3-Axis, $\pm 2 g/\pm 4 g/\pm 8 g$ **Digital Output MEMS Accelerometer**

Data Sheet

FEATURES

Ultralow power Power can be derived from coin cell battery 1.8 µA @ 100 Hz ODR, 2.0 V supply 3.0 µA @ 400 Hz ODR, 2.0 V supply 270 nA motion activated wake-up mode 10 nA standby current High resolution: 1 mg/LSB Built-in features for system-level power savings: Adjustable threshold sleep/wake modes for motion activation Autonomous interrupt processing, without need for microcontroller intervention, to allow the rest of the system to be turned off completely Deep embedded FIFO minimizes host processor load Awake state output enables implementation of standalone, motion activated switch Low noise down to 175 $\mu a/\sqrt{Hz}$ Wide supply and I/O voltage ranges: 1.6 V to 3.5 V Operates off 1.8 V to 3.3 V rails Acceleration sample synchronization via external trigger **On-chip temperature sensor SPI digital interface** Measurement ranges selectable via SPI command Small and thin 3 mm × 3.25 mm × 1.06 mm package **APPLICATIONS**

Hearing aids Home healthcare devices Motion enabled power save switches Wireless sensors Motion enabled metering devices

GENERAL DESCRIPTION

The ADXL362 is an ultralow power, 3-axis MEMS accelerometer that consumes less than 2 μ A at a 100 Hz output data rate and 270 nA when in motion triggered wake-up mode. Unlike accelerometers that use power duty cycling to achieve low power consumption, the ADXL362 does not alias input signals by undersampling; it samples the full bandwidth of the sensor at all data rates.

ADXL362

The ADXL362 always provides 12-bit output resolution; 8-bit formatted data is also provided for more efficient single-byte transfers when a lower resolution is sufficient. Measurement ranges of ± 2 g, ± 4 g, and ± 8 g are available, with a resolution of 1 mg/LSB on the $\pm 2 \text{ g}$ range. For applications where a noise level lower than the normal 550 $\mu g/\sqrt{Hz}$ of the ADXL362 is desired, either of two lower noise modes (down to 175 $\mu g/\sqrt{\text{Hz}}$ typical) can be selected at minimal increase in supply current.

In addition to its ultralow power consumption, the ADXL362 has many features to enable true system level power reduction. It includes a deep multimode output FIFO, a built-in micropower temperature sensor, and several activity detection modes including adjustable threshold sleep and wake-up operation that can run as low as 270 nA at a 6 Hz (approximate) measurement rate. A pin output is provided to directly control an external switch when activity is detected, if desired. In addition, the ADXL362 has provisions for external control of sampling time and/or an external clock.

The ADXL362 operates on a wide 1.6 V to 3.5 V supply range, and can interface, if necessary, to a host operating on a separate, lower supply voltage. The ADXL362 is available in a 3 mm × $3.25 \text{ mm} \times 1.06 \text{ mm}$ package.



FUNCTIONAL BLOCK DIAGRAM

Rev. B

Figure 1.

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REVISION HISTORY

2/13—Rev. A to Rev. B

Change to Figure 7
Changes to Figure 11, Figure 12, and Figure 139
Changes to Table 7 and Table 814
Changes to Figure 31
Change to Table 10
Change to Bit 6, Table 1225
Changes to Inactivity Time Registers Section
Change to LINK/LOOP Bit, Table 13
Change to ODR Bit, Table 17
Changes to Figure 43, Figure 44, and Figure 45
Changes to Startup Routine Section, Figure 46, and
Figure 47
Change to Figure 5242

9/12—Rev. 0 to Rev. A

Moved Revision History Section	3
Changes to Linking Activity and Inactivity Detection Section;	
Added Figure 31, Figure 32, and Figure 33, Renumbered	
Sequentially16	5
Change to Table 1329)
Changes to Figure 44	5
Moved Power Supply Decoupling Section	7
Added Power Section, Power Supply Requirements Section, and	l
Figure 47	7
Updated Outline Dimensions43	3
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8/12—Revision 0: Initial Version

SPECIFICATIONS

 $T_A = 25^{\circ}$ C, $V_S = 2.0$ V, $V_{DD I/O} = 2.0$ V, 100 Hz ODR, acceleration = 0 g, default register settings, unless otherwise noted.¹

Parameter	Test Conditions/Comments	Min	Тур	Мах	Unit
SENSOR INPUT	Each axis				
Measurement Range	User selectable		±2, ±4, ±8		g
Nonlinearity	Percentage of full scale		±0.5		%
Sensor Resonant Frequency	5		3500		Hz
Cross Axis Sensitivity ²			±1.5		%
OUTPUT RESOLUTION	Each axis				
All g Ranges			12		Bits
SENSITIVITY	Each axis				
Sensitivity Calibration Error				±10	%
Sensitivity at Xout, Yout, Zout	2 g range		1		mg/LSB
, , , , , , , , , , , , , , , , , , ,	4 <i>g</i> range		2		mg/LSB
	8 <i>g</i> range		4		mg/LSB
Scale Factor at Xour, Your, Zour	2 g range		1000		LSB/g
	4 <i>g</i> range		500		LSB/g
	8 g range		250		LSB/g
Sensitivity Change Due to Temperature ³	-40°C to +85°C		0.05		%/°C
0 g OFFSET	Each axis		0.05		707 C
0 <i>g</i> Output	Xout, Yout	-150	±35	+150	m <i>q</i>
o y Output	Z _{out}	-250	±50	+250	mg
0 g Offset vs. Temperature ³	2001	-250	±30	7250	ing
Normal Operation	Xout, Yout		±0.5		mg/℃
Normal Operation			±0.5 ±0.6		mg/°C
Low Noise Mode and Ultralow Noise			±0.8 ±0.35		mg/°C
Mode	Xout, Yout, Zout		±0.55		ing/ C
NOISE PERFORMANCE					
Noise Density					
Normal Operation	Хоит, Үоит		550		μ <i>g/</i> √Hz
	Zout		920		μ <i>g/</i> √Hz
Low Noise Mode	Xout, Yout		400		µg/√Hz
	Zout		550		µg/√Hz
Ultralow Noise Mode	Xout, Yout		250		µg/√Hz
	Zout		350		µg/√Hz
	$V_{s} = 3.5 V; X_{OUT}, Y_{OUT}$		175		µg/√Hz
	V _s = 3.5 V; Z _{OUT}		250		µg/√Hz
BANDWIDTH					13.
Low Pass (Antialiasing) Filter, –3 dB	$HALF_BW = 0$		ODR/2		Hz
Corner	$HALF_BW = 1$		ODR/4		Hz
Output Data Rate (ODR)	User selectable in 8 steps	12.5	0011/1	400	Hz
SELF TEST		12.5		100	
Output Change ⁴	X _{OUT}	450	580	710	m <i>g</i>
e a par enange	Yout	-710	-580	-450	mg
	Zout	350	500	650	mg
POWER SUPPLY		550	200	0.00	ing
Operating Voltage Range (V _s)		1.6	2.0	3.5	v
I/O Voltage Range (V _{DD I/O})		1.6	2.0		V
I/O VOILage hange (VDDI/O)		1.0	2.0	Vs	v

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Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
Supply Current					
Measurement Mode	100 Hz ODR (50 Hz bandwidth)⁵				
Normal Operation			1.8		μA
Low Noise Mode			3.3		μΑ
Ultralow Noise Mode			13		μΑ
Wake-Up Mode			0.27		μΑ
Standby			0.01		μΑ
Power Supply Rejection Ratio (PSRR)	$C_s = 1.0 \ \mu$ F, $R_s = 100 \ \Omega$, $C_{10} = 1.1 \ \mu$ F, input is 100 mV sine wave on V_s				
Input Frequency 100 Hz to 1 kHz			-13		dB
Input Frequency 1 kHz to 250 kHz			-20		dB
Turn-On Time	100 Hz ODR (50 Hz bandwidth)				
Power-Up to Standby			5		ms
Measurement Mode Instruction to Valid Data			4/ODR		
TEMPERATURE SENSOR					
Bias	@ 25°C		350		LSB
Standard Deviation			290		LSB
Sensitivity Average	@ 25°C		0.065		°C/LSB
Standard Deviation			0.0025		°C/LSB
Sensitivity Repeatability	@ 25°C		±0.5		°C
Resolution			12		Bits
ENVIRONMENTAL					
Operating Temperature Range		-40		+85	°C

¹ All minimum and maximum specifications are guaranteed. Typical specifications may not be guaranteed. ² Cross axis sensitivity is defined as coupling between any two axes. ³ -40°C to +25°C or +25°C to +85°C. ⁴ Self test change is defined as the output change in *g* when self test is asserted. ⁵ Refer to Figure 30 for current consumption at other bandwidth settings.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Acceleration (Any Axis, Unpowered)	5000 g
Acceleration (Any Axis, Powered)	5000 g
Vs	–0.3 V to +3.6 V
V _{DD I/O}	–0.3 V to +3.6 V
All Other Pins	-0.3 V to Vs
Output Short-Circuit Duration (Any Pin to Ground)	Indefinite
ESD	2000 V (HBM)
Short Term Maximum Temperature	
Four Hours	150°C
One Minute	260°C
Temperature Range (Powered)	-50°C to +150°C
Temperature Range (Storage)	-50°C to +150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

Table 3. Package Characteristics

Package Type	θ _{JA}	θις	Device Weight
16-Terminal LGA	150°C/W	85°C/W	18 mg

PACKAGE INFORMATION

Figure 2 and Table 4 provide details about the package branding for the ADXL362. For a complete listing of product availability, see the Ordering Guide section.



Figure 2. Product Information on Package (Top View)

Table 4. Package Branding Information

Branding Key	Field Description		
•362B	Pin 1 indicator and part identifier		
#yww	Pb-free designator (#) and date code		
VVVV	Factory lot code		

RECOMMENDED SOLDERING PROFILE

Figure 3 and Table 5 provide details about the recommended soldering profile.



Figure 3. Recommended Soldering Profile

Table 5. Recommended Soldering Profile

	Conc	lition
Profile Feature	Sn63/Pb37	Pb-Free
Average Ramp Rate $(T_L to T_P)$	3°C/sec max	3°C/sec max
Preheat		
Minimum Temperature (T _{SMIN})	100°C	150°C
Maximum Temperature (T _{SMAX})	150°C	200°C
Time (T _{SMIN} to T _{SMAX})(t _s)	60 sec to 120 sec	60 sec to 180 sec
T_{SMAX} to T_L Ramp-Up Rate	3°C/sec max	3°C/sec max
Time Maintained Above Liquidous (Tı)		
Liquidous Temperature (T∟)	183°C	217°C
Time (t∟)	60 sec to 150 sec	60 sec to 150 sec
Peak Temperature (T _P)	240 + 0/-5°C	260 + 0/-5°C
Time Within 5°C of Actual Peak Temperature (t _P)	10 sec to 30 sec	20 sec to 40 sec
Ramp-Down Rate	6°C/sec max	6°C/sec max
Time 25°C to Peak Temperature	6 minutes max	8 minutes max

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 4. Pin Configuration (Top View)

Table 6. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V _{DD I/O}	Supply Voltage for Digital I/O.
2	NC	No Connect. Not internally connected.
3	Reserved	Reserved. Can be left unconnected or connected to GND.
4	SCLK	SPI Communications Clock.
5	Reserved	Reserved. Can be left unconnected or connected to GND.
6	MOSI	Master Output, Slave Input. SPI serial data input.
7	MISO	Master Input, Slave Output. SPI serial data output.
8	CS	SPI Chip Select, Active Low. Must be low during SPI communications.
9	INT2	Interrupt 2 Output. INT2 also serves as an input for synchronized sampling.
10	Reserved	Reserved. Can be left unconnected, or connected to GND.
11	INT1	Interrupt 1 Output. INT1 also serves as an input for external clocking.
12	GND	Ground. This pin must be grounded.
13	GND	Ground. This pin must be grounded.
14	Vs	Supply Voltage.
15	NC	No Connect. Not internally connected.
16	GND	Ground. This pin must be grounded.

TYPICAL PERFORMANCE CHARACTERISTICS





Data Sheet

ADXL362

10776-014

100

80

80

80

100

10776-016

100

10776-015









Data Sheet





THEORY OF OPERATION

The ADXL362 is a complete 3-axis acceleration measurement system that operates at extremely low power consumption levels. It measures both dynamic acceleration, resulting from motion or shock, and static acceleration, such as tilt. Acceleration is reported digitally and the device communicates via the SPI protocol. Built-in digital logic enables autonomous operation and implements functionality that enhances system level power savings.

MECHANICAL DEVICE OPERATION

The moving component of the sensor is a polysilicon surfacemicromachined structure that is built on top of a silicon wafer. Polysilicon springs suspend the structure over the surface of the wafer and provide a resistance against acceleration forces.

Deflection of the structure is measured using differential capacitors that consist of independent fixed plates and plates attached to the moving mass. Acceleration deflects the structure and unbalances the differential capacitor, resulting in a sensor output whose amplitude is proportional to acceleration. Phase sensitive demodulation determines the magnitude and polarity of the acceleration.

OPERATING MODES

The ADXL362 has two operating modes: measurement mode for continuous, wide bandwidth sensing; and wake-up mode for limited bandwidth activity detection. In addition, measurement can be suspended altogether by placing the device in standby.

Measurement Mode

Measurement mode is the normal operating mode of the ADXL362. In this mode, acceleration data is read continuously and the accelerometer consumes less than 3 μ A (typical) across its entire range of output data rates of up to 400 Hz using a 2.0 V supply. All features described in this datasheet are available when operating the ADXL362 in this mode.

The ability to continuously output data from the minimum 12.5 Hz to the maximum 400 Hz data rate while still delivering less than 3 μ A (typical) of current consumption is what defines the ADXL362 as an ultralow power accelerometer. Other accelerometers derive low current by using a specific low power mode that power cycles acceleration sensing. The result is a small effective bandwidth in the low power modes and undersampling of input data; therefore, unwanted aliasing can occur. Undersampling and aliasing do not occur with the ADXL362 because it continuously samples the full bandwidth of its sensor at all data rates.

Wake-Up Mode

Wake-up mode is ideal for simple detection of the presence or absence of motion at extremely low power consumption (270 nA at a 2.0 V supply voltage). Wake-up mode is useful particularly for implementation of a motion activated on/off switch, allowing the rest of the system to be powered down until activity is detected.

Wake-up mode reduces current consumption to a very low level by measuring acceleration only about six times per second to determine whether motion is present. If motion is detected, the accelerometer can respond autonomously in the following ways:

- Switch into full bandwidth measurement mode
- Signal an interrupt to a microcontroller
- Wake up downstream circuitry, depending on the configuration

In wake-up mode, all accelerometer features are available with the exception of the activity timer. All registers can be accessed, and real-time data can be read and/or stored in the FIFO.

Standby

Placing the ADXL362 in standby suspends measurement and reduces current consumption to 10 nA (typical). Pending interrupts and data are preserved and no new interrupts are generated.

The ADXL362 powers up in standby with all sensor functions turned off.

SELECTABLE MEASUREMENT RANGES

The ADXL362 has selectable measurement ranges of $\pm 2 g$, $\pm 4 g$, and $\pm 8 g$. Acceleration samples are always converted by a 12-bit ADC; therefore, sensitivity scales with *g* range. Ranges and corresponding sensitivity values are listed in Table 1.

When acceleration exceeds the measurement extremes, data is clipped at the full-scale value (0x0FFF), and no damage is caused to the accelerometer. Table 2 lists the absolute maximum ratings for acceleration, indicating the acceleration level that can cause permanent damage to the device.

SELECTABLE OUTPUT DATA RATES

The ADXL362 can report acceleration data at various data rates ranging from 12.5 Hz to 400 Hz. The internal low-pass filter pole is automatically set to ¼ or ½ the selected ODR (based on the HALF_BW setting) to ensure the Nyquist sampling criterion is met and no aliasing occurs.

Current consumption varies somewhat with output data rate as shown in Figure 30, remaining below 5.0 μ A over the entire range of data rates and operating voltages.



Figure 30. Current Consumption vs. Output Data Rate at Several Supply Voltages

Antialiasing

The analog-to-digital converter (ADC) of the ADXL362 samples at the (user selected) output data rate. In the absence of antialiasing filtering, it aliases any input signals whose frequency is more than half the data rate. To mitigate this, a two-pole lowpass filter is provided at the input of the ADC.

The user can set this antialiasing filter to a bandwidth that is at $\frac{1}{2}$ the data rate or $\frac{1}{4}$ the data rate. Setting the antialiasing filter pole to $\frac{1}{2}$ of the output data rate provides less aggressive antialiasing filtering, but maximizes bandwidth and is adequate for most applications. Setting the pole to $\frac{1}{4}$ of the data rate reduces bandwidth for a given data rate, but provides more aggressive antialiasing.

The antialiasing filter of the ADXL362 defaults to the more conservative setting, where bandwidth is set to one-fourth the output data rate.

POWER/NOISE TRADEOFF

The ADXL362 offers a few options for decreasing noise at the expense of only a small increase in current consumption.

The noise performance of the ADXL362 in normal operation, typically 7 LSB rms at 100 Hz bandwidth, is adequate for most applications, depending upon bandwidth and the desired resolution. For cases where lower noise is needed, the ADXL362 provides two lower noise operating modes that trade reduced noise for a somewhat higher current consumption.

Table 7 lists the current consumption and noise densities obtained for normal operation and the two lower noise modes at a typical 2.0 V supply.

Table 7. Noise and Current Consumption: Normal Operation, Low Noise Mode, and Ultralow Noise Mode @ $V_s = 2.0 V$, ODR = 100 Hz

Mode	Noise (µ <i>g</i> /√Hz) Typical	Current Consumption (µA) Typical
Normal Operation	550	1.8
Low Noise	400	3.3
Ultralow Noise	250	13

Operating the ADXL362 at a higher supply voltage also decreases noise. Table 8 lists the current consumption and noise densities obtained for normal operation and the two lower noise modes at the highest recommended supply, 3.3 V.

Table 8. Noise and Current Consumption: Normal Operation, Low Noise Mode, and Ultralow Noise Mode @ $V_s = 3.3 V$, ODR = 100 Hz

Mode	Noise (µg/√Hz) Typical	Current Consumption (µA) Typical
Normal Operation	380	2.7
Low Noise	280	4.5
Ultralow Noise	175	15

POWER SAVINGS FEATURES

Designed for the most power conscious applications, the ADXL362 includes several features (as described in this section) for enabling power savings at the system level, as well as at the device level.

ULTRALOW POWER CONSUMPTION IN ALL MODES

At the device level, the most obvious power saving feature of the ADXL362 is its ultralow current consumption in all configurations. The ADXL362 consumes between 1.1 μ A (typical) and 5 μ A (typical) across all data rates up to 400 Hz and all supply voltages up to 3.5 V (see Figure 30). An even lower power, 270 nA (typical) motion triggered wake-up mode is provided for simple motion detection applications that require a power consumption lower than 1 μ A.

At these current levels, the accelerometer consumes less power in full operation than the standby currents of many other system components, and is, therefore, optimal for applications that require continuous acceleration monitoring and very long battery life. Because the accelerometer is always on, it can act as a motion activation switch. The accelerometer signals to the rest of the system when to turn on, thereby managing power at the system level.

As important as its low operating current, the 10 nA (typical) standby current of the ADXL362 contributes to a much longer battery life in applications that spend most of their time in a sleep state and wake up via an external trigger.

MOTION DETECTION

The ADXL362 features built-in logic that detects activity (presence of acceleration above a threshold) and inactivity (lack of acceleration above a threshold). Activity and inactivity events can be used as triggers to manage the accelerometer mode of operation, trigger an interrupt to a host processor, and/or autonomously drive a motion switch.

Detection of an activity or inactivity event is indicated in the status register and can be configured to generate an interrupt. In addition, the activity status of the device, that is, whether it is moving or stationary, is indicated by the AWAKE bit, described in the Using the AWAKE Bit section.

Activity and inactivity detection can be used when the accelerometer is in either measurement mode or wake-up mode.

Activity Detection

An activity event is detected when acceleration remains above a specified threshold for a specified time period.

Referenced and Absolute Configurations

Activity detection can be configured as referenced or absolute.

When using absolute activity detection, acceleration samples are compared to a user set threshold to determine whether motion is present. For example, if a threshold of 0.5 g is set and the acceleration on the z-axis is 1 g for longer than the user defined activity time, the activity status asserts.

In many applications, it is advantageous for activity detection to be based not on an absolute threshold, but on a deviation from a reference point or orientation. This is particularly useful because it removes the effect on activity detection of the static 1 *g* imposed by gravity. When an accelerometer is stationary, its output can reach 1 *g*, even when it is not moving. In absolute activity, when the threshold is set to less than 1 *g*, activity is immediately detected in this case.

In the referenced configuration, activity is detected when acceleration samples are at least a user set amount above an internally defined reference for the user defined amount of time, as described in Equation 1.

ABS(Acceleration - Reference) > Threshold(1)

Consequently, activity is detected only when the acceleration has deviated sufficiently from the initial orientation. The reference for activity detection is calculated when activity detection is engaged in the following scenarios:

- When the activity function is turned on and measurement mode is engaged;
- If link mode is enabled: when inactivity is detected and activity detection begins; or
- If link mode is not enabled: when activity is detected and activity detection repeats.

The referenced configuration results in a very sensitive activity detection that detects even the most subtle motion events.

Fewer False Positives

Ideally, the intent of activity detection is to wake up a system only when motion is intentional, ignoring noise or small, unintentional movements. In addition to being sensitive to subtle motion events, the ADXL362 activity detection algorithm is designed to be robust in filtering out undesired triggers.

The ADXL362 activity detection functionality includes a timer to filter out unwanted motion and ensure that only sustained motion is recognized as activity. The duration of this timer, as well as the acceleration threshold, are user adjustable from one sample (that is, no timer) to up to 20 seconds of motion.

Note that the activity timer is operational in measurement mode only. In wake-up mode, one-sample activity detection is used.

Inactivity Detection

An inactivity event is detected when acceleration remains below a specified threshold for a specified time. Inactivity detection is also configurable as referenced or absolute.

When using absolute inactivity detection, acceleration samples are compared to a user set threshold for the user set time to determine the absence of motion. Inactivity is detected when enough consecutive samples are all below the threshold. The absolute configuration of inactivity should be used for implementing free fall detection.

When using referenced inactivity detection, inactivity is detected when acceleration samples are within a user specified amount of an internally defined reference (as described by Equation 2) for a user defined amount of time.

ABS(Acceleration - Reference) < Threshold (2)

Referenced inactivity, like referenced activity, is particularly useful for eliminating the effects of the static acceleration due to gravity. With absolute inactivity, if the inactivity threshold is set lower than 1 *g*, a device resting motionless may never detect inactivity. With referenced inactivity, the same device under the same configuration detects inactivity.

The inactivity timer can be set to anywhere from 2.5 ms (a single sample at 400 Hz ODR) to almost 90 minutes (65,535 samples at 12.5 Hz ODR) of inactivity. A requirement for inactivity detection is that for whatever period of time the inactivity timer has been configured, the accelerometer detects inactivity only when it has been stationary for that amount of time.

For example, if the accelerometer has been configured for 90 minutes, the accelerometer detects inactivity when it has been stationary for 90 minutes. The wide range of timer settings means that in applications where power conservation is critical, the system can be put to sleep after very short periods of inactivity. In applications where continuous operation is critical, the system stays on for as long as any motion is present.

Linking Activity and Inactivity Detection

The activity and inactivity detection functions can be used concurrently and processed manually by a host processor, or they can be configured to interact in several other ways, as follows.

Default Mode

The user must enable the activity and inactivity functions because these functions are not automatically enabled by default. After the user enables the activity and inactivity functions, the ADXL362 exhibits the following behavior when it enters default mode: Both activity and inactivity detection remain enabled and all interrupts must be serviced by a host processor; that is, a processor must read each interrupt before it is cleared and can be used again.

Loop mode operation is illustrated in the flowchart in Figure 32.

Linked Mode

In linked mode, activity and inactivity detection are linked to each other such that only one of the functions is enabled at any given time. As soon as activity is detected, the device is assumed to be moving (or awake) and stops looking for activity; rather, inactivity is expected as the next event. Therefore, only inactivity detection operates.

Similarly, when inactivity is detected, the device is assumed to be stationary (or asleep). Thus, activity is expected as the next event; therefore, only activity detection operates.



Figure 31. Flowchart Illustrating Activity and Inactivity Operation in Default Mode

In linked mode, each interrupt must be serviced by a host processor before the next interrupt is enabled.

Linked mode operation is illustrated in the flowchart in Figure 32.



Figure 32. Flowchart Illustrating Activity and Inactivity Operation in Linked Mode

Loop Mode

In loop mode, motion detection operates as described in the Linked Mode section, but interrupts do not need to be serviced by a host processor. This configuration simplifies the implementation of commonly used motion detection and enhances power savings by reducing the amount of power used in bus communication.

Loop mode operation is illustrated in the flowchart in Figure 33.





Autosleep

When in linked or loop mode, enabling autosleep causes the device to enter wake-up mode autonomously (see the Wake-Up Mode section) when inactivity is detected, and to reenter measurement mode when activity is detected.

The autosleep configuration is active only if linked or loop modes are enabled. In the default mode, the autosleep setting is ignored.

Using the AWAKE Bit

The AWAKE bit is a status bit that indicates whether the ADXL362 is awake or asleep. The device is awake when it has experienced an activity condition, and it is asleep when it has experienced an inactivity condition.

The awake signal can be mapped to the INT1 or INT2 pin, allowing the pin to serve as a status output to connect or disconnect power to downstream circuitry based on the awake status of the accelerometer. Used in conjunction with loop mode, this configuration implements a trivial, autonomous motion activated switch, as shown in Figure 43.

If the turn-on time of downstream circuitry can be tolerated, this motion switch configuration can save significant system level power by eliminating the standby current consumption of the remainder of the application. This standby current can often exceed the full operating current of the ADXL362.

FIFO

The ADXL362 includes a deep 512-sample first in, first out (FIFO) buffer. The FIFO provides benefits primarily in two ways, as follows.

System Level Power Savings

Appropriate use of the FIFO enables system level power savings by enabling the host processor to sleep for extended periods of time while the accelerometer autonomously collects data. Alternatively, using the FIFO to collect data can unburden the host while it tends to other tasks.

Data Recording/Event Context

The FIFO can be used in a triggered mode to record all data leading up to an activity detection event, thereby providing context for the event. In the case of a system that identifies impact events, for example, the accelerometer can keep the entire system off while it stores acceleration data in its FIFO and looks for an activity event. When the impact event occurs, data that was collected prior to the event is frozen in the FIFO. The accelerometer can then wake the rest of the system and transfer this data to the host processor, thereby providing context for the impact event.

Generally, the more context available, the more intelligent decisions a system can achieve, making a deep FIFO especially useful. The ADXL362 FIFO can store up to more than 13 seconds of data, providing a clear picture of events prior to an activity trigger.

All FIFO modes of operation, as well as the structure of the FIFO and instructions for retrieving data from it, are described in further detail in the FIFO Modes section of this data sheet.

COMMUNICATIONS

SPI Instructions

The digital interface of the ADXL362 is implemented with system level power savings in mind. The following features enhance power savings:

- Burst reads and writes reduce the number of SPI communication cycles required to configure the part and retrieve data.
- Concurrent operation of activity and inactivity detection enables "set it and forget it" operation. Loop mode further reduces communications power by enabling the clearing of interrupts without processor intervention.
- The FIFO is implemented such that consecutive samples can be read continuously via a multibyte read of unlimited length; thus, one read FIFO instruction can clear the entire contents of the FIFO. In many other accelerometers, each read instruction retrieves a single sample only. In addition, the ADXL362 FIFO construction allows the use of direct memory access (DMA) to read the FIFO contents.

Bus Keepers

The ADXL362 includes bus keepers on all digital interface pins: MISO, MOSI, SCLK, \overline{CS} , INT1, and INT2. Bus keepers are used to prevent tristate bus lines from floating when nothing is driving them, thus preventing through current in any gate inputs that are on the bus.

MSB Registers

Acceleration and temperature measurements are converted to 12-bit values and transmitted via SPI using two registers per measurement. To read a full sample set of 3-axis acceleration data, six registers must be read.

Many applications do not require the accuracy that 12-bit data provides and prefer, instead, to save system level power. The MSB registers XDATA, YDATA, and ZDATA enable this tradeoff. These registers contain the eight MSBs of the x-, y-, and z-axis acceleration data; reading them effectively provides 8-bit acceleration values. Importantly, only three (consecutive) registers must be read to retrieve a full data set, significantly reducing the time during which the SPI bus is active and drawing current.

12-bit and 8-bit data are available simultaneously so that both data formats can be used in a single application, depending on the needs of the application at a given time. For example, the processor can read 12-bit data when higher resolution is required, and switch to 8-bit data (simply by reading a different set of registers) when application requirements change.

ADDITIONAL FEATURES FREE FALL DETECTION

Many digital output accelerometers include a built-in free fall detection feature. In the ADXL362, this function can be implemented using the inactivity interrupt. Refer to the Applications Information section for more details, including suggested threshold and timing values.

EXTERNAL CLOCK

The ADXL362 has a built-in 51.2 kHz (typical) clock that, by default, serves as the time base for internal operations.

ODR and bandwidth scale proportionally with the clock. The ADXL362 provides a discrete number of options for ODR, such as 100 Hz, 50 Hz, 25 Hz, and so forth, in factors of 2, (see the Filter Control Register section for a complete listing). To achieve data rates other than those provided, an external clock can be used at the appropriate clock frequency. The output data rate scales with the clock frequency, as shown in Equation 3.

$$ODR_{ACTUAL} = ODR_{SELECTED} \times \frac{f}{51.2 \,\mathrm{kHz}}$$
 (3)

For example, to achieve an 80 Hz ODR, select the 100 Hz ODR setting and provide a clock frequency that is 80% of nominal, or 41.0 kHz.

The ADXL362 can operate with external clock frequencies ranging from the nominal 51.2 kHz down to 25.6 kHz to allow the user to achieve any desired output data rate.

Alternatively, an external clock can be used to improve clock frequency accuracy. The distribution of clock frequencies among a sampling of >1000 parts has a standard deviation of approximately 3%. To achieve tighter tolerances, a more accurate clock can be provided externally.

Bandwidth automatically scales to ½ or ¼ of the ODR (based on the HALF_BW setting), and this ratio is preserved, regardless of clock frequency. Power consumption also scales with clock frequency: higher clock rates increase power consumption. Figure 34 shows how power consumption varies with clock rate.



SYNCHRONIZED DATA SAMPLING

For applications that require a precisely timed acceleration measurement, the ADXL362 features an option to synchronize acceleration sampling to an external trigger.

SELF TEST

The ADXL362 incorporates a self test feature that effectively tests its mechanical and electronic systems simultaneously. When the self test function is invoked, an electrostatic force is applied to the mechanical sensor. This electrostatic force moves the mechanical sensing element in the same manner as acceleration, and it is additive to the acceleration experienced by the device. This added electrostatic force results in an output change on all three axes.

USER REGISTER PROTECTION

The ADXL362 includes user register protection for single event upsets (SEUs). An SEU is a change of state caused by ions or electromagnetic radiation striking a sensitive node in a microelectronic device. The state change is a result of the free charge created by ionization in or close to an important node of a logic element (for example, a memory bit). The SEU, itself, is not considered permanently damaging to transistor or circuit functionality, but it can create erroneous register values. The ADXL362 registers that are protected from SEU are Register 0x20 to Register 0x2E.

SEU protection is implemented via a 99-bit error correcting (Hamming-type) code that detects both single- and double-bit errors. The check bits are recomputed any time a write to any of the protected registers occurs. At any time, if the stored version of the check bits is not in agreement with the current check bit calculation, the ERR_USER_REGS status bit is set.

The SEU bit in the status register is set on power-up prior to device configuration; it clears upon the first register write to that device.

TEMPERATURE SENSOR

The ADXL362 includes an integrated temperature sensor that can monitor internal system temperature or improve the temperature stability of the device via calibration. For example, acceleration outputs vary with temperature at a rate of ± 0.5 mg/°C (typical), but the relationship to temperature is repeatable and can be calibrated.

To use the temperature sensor to monitor absolute temperature, it is recommended that its initial bias (its output at some known temperature) is measured and calibrated.

SERIAL COMMUNICATIONS

The ADXL362 communicates via a 4-wire SPI and operates as a slave. Ignore data that is transmitted from the ADXL362 to the master device during writes to the ADXL362.

As shown in Figure 36 to Figure 40, the MISO pin is in a high impedance state, held by a bus keeper, except when the ADXL362 is sending read data (to conserve bus power).

Wire the ADXL362 for SPI communication as shown in the connection diagram in Figure 35. The recommended SPI clock speeds are 1 MHz to 5 MHz, with 12 pF maximum loading.

The SPI timing scheme follows CPHA = CPOL = 0.

For correct operation of the part, the logic thresholds and timing parameters in Table 9 and Table 10 must be met at all times. Refer to Figure 41 and Figure 42 for visual diagrams of the timing parameters.





SPI COMMANDS

The SPI port uses a multibyte structure wherein the first byte is a command. The ADXL362 command set is

- 0x0A: write register
- 0x0B: read register
- 0x0D: read FIFO

Read and Write Register Commands

The command structure for the read register and write register commands is as follows (see Figure 36 and Figure 37):

</CS down> <command byte (0x0A or 0x0B)> <address byte> <data byte> <additional data bytes for multi-byte> ... </CS up>

The read and write register commands support multibyte (burst) read/write access. The waveform diagrams for multibyte read and write commands are shown in Figure 38 and Figure 39.

Read FIFO Command

Reading from the FIFO buffer is a command structure that does not have an address.

</CS down> <command byte (0x0D)> <data byte> <data byte> <data byte> ... </CS up>

It is recommended that an even number of bytes be read (using a multibyte transaction) because each sample consists of two bytes: 2 bits of axis information and 14 bits of data. If an odd number of bytes is read, it is assumed that the desired data was read; therefore, the second half of the last sample is discarded so a read from the FIFO always starts on a properly aligned evenbyte boundary. Data is presented least significant byte first, followed by the most significant byte.

MULTIBYTE TRANSFERS

Multibyte transfers, also known as burst transfers, are supported for all SPI commands: register read, register write, and FIFO read commands. It is recommended that data be read using multibyte transfers to ensure that a concurrent and complete set of x-, y-, and z-acceleration (and temperature, where applicable) data is read.

The FIFO runs on the serial port clock during FIFO reads and can sustain bursting at the SPI clock rate as long as the SPI clock is 1 MHz or faster.

Register Read/Write Auto-Increment

A register read or write command begins with the address specified in the command and auto-increments for each additional byte in the transfer. To avoid address wrapping and side effects of reading registers multiple times, the autoincrement halts at the invalid Register Address 63 (0x3F).

INVALID ADDRESSES AND ADDRESS FOLDING

The ADXL362 has a 6-bit address bus, mapping only 64 registers in the possible 256 register address space. The addresses do not fold to repeat the registers at addresses above 64. Attempted access to register addresses above 64 are mapped to the invalid register at 63 (0x3F) and have no functional effect.

Address 0x00 to Address 0x2E are for customer access, as described in the register map. Address 0x2F to Address 0x3F are reserved for factory use.

LATENCY RESTRICTIONS

Reading any of the data registers (0x08 to 0x0A or 0x0E to 0x15) clears the data ready interrupt. There can be as much as an 80 μ s delay from reading a register to the clearing of the data ready interrupt.

Other register reads, register writes, and FIFO reads have no latency restrictions.

INVALID COMMANDS

Commands other than 0x0A, 0x0B, and 0x0D have no effect. The MISO output remains in a high impedance state, and the bus keeper holds the MISO line at its last value.





Figure 41. Timing Diagram for SPI Write Instructions



Figure 42. Timing Diagram for SPI Read Instructions

Table 9. SPI Digital Input/Output

			Limit ¹	
Parameter	Test Conditions/Comments	Min	Max	Unit
Digital Input				
Low Level Input Voltage (V _{IL})			$0.3 imes V_{\text{DD I/O}}$	V
High Level Input Voltage (V _H)		$0.7 \times V_{\text{DD I/O}}$		V
Low Level Input Current (IIL)	$V_{IN} = V_{DD I/O}$		0.1	μΑ
High Level Input Current (I⊪)	$V_{IN} = 0 V$	-0.1		μΑ
Digital Output				
Low Level Output Voltage (VoL)	I _{OL} = 10 mA		$0.2 imes V_{\text{DD I/O}}$	V
High Level Output Voltage (Vон)	$I_{OH} = -4 \text{ mA}$	$0.8 imes V_{\text{DD I/O}}$		V
Low Level Output Current (IoL)	$V_{OL} = V_{OL, max}$	10		mA
High Level Output Current (Іон)	$V_{OH} = V_{OH, min}$		-4	mA

¹ Limits based on characterization results, not production tested.

-	Lin	nit ^{1, 2}		
Parameter	Min	Мах	Unit	Description
f _{CLK}		1	MHz	Clock Frequency
Css	100		ns	CS Setup Time
t _{CSH}	100		ns	CS Hold Time
t _{CSD}	10		ns	CS Disable Time
t su	50		ns	Data Setup Time
t _{HD}	50		ns	Data Hold Time
t _R	0	100	ns	SCLK Rise Time
t _F	0	100	ns	SCLK Fall Time
thigh	100		ns	Clock High Time
tLOW	100		ns	Clock Low Time
t _{cld}	100		ns	Clock Delay Time
t _{CLE}	100		ns	Clock Enable Time
t _v	0		ns	Output Valid from Clock Low
t _{HO}	0	200	ns	Output Hold Time
t _{DIS}	0	200	ns	Output Disable Time

Table 10. SPI Timing $(T_A = 25^{\circ}C, V_S = 2.0 \text{ V}, V_{DD I/O} = 2.0 \text{ V})$

 1 Limits based on design targets; not production tested. 2 The timing values are measured corresponding to the input thresholds (V_L and V_H) given in Table 9.

REGISTER MAP

Table 11. Register Summary

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bi	it 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	RW
0x00	DEVID_AD	[7:0]				•	DEVI	D_AD[7:0]				0xAD	R
0x01	DEVID_MST	[7:0]					DEVID	_MST[7:0]				0x1D	R
0x02	PARTID	[7:0]					PAF	TID[7:0]				0xF2	R
0x03	REVID	[7:0]					REV	/ID[7:0]				0x01	R
0x08	XDATA	[7:0]					XD/	ATA[7:0]				0x00	R
0x09	YDATA	[7:0]					YD/	ATA[7:0]				0x00	R
0x0A	ZDATA	[7:0]					ZD/	ATA[7:0]				0x00	R
0x0B	STATUS	[7:0]	ERR_USER_ REGS	AWAKE	INACT	A	ст	FIFO_OVER- RUN	FIFO_WATER- MARK	FIFO_READY	DATA_READY	0x40	R
0x0C	FIFO_ENTRIES_L	[7:0]					FIFO_EN	TRIES_L[7:0]				0x00	R
0x0D	FIFO_ENTRIES_H	[7:0]				UNUS	ED			FIFO_ENTRIES	_H[1:0]	0x00	R
0x0E	XDATA_L	[7:0]					XDA	ΓA_L[7:0]				0x00	R
0x0F	XDATA_H	[7:0]			SX				XDATA	A_H[3:0]		0x00	R
0x10	YDATA_L	[7:0]					YDA	ΓA_L[7:0]				0x00	R
0x11	YDATA_H	[7:0]			SX				YDATA	_H[3:0]		0x00	R
0x12	ZDATA_L	[7:0]					ZDA	ΓA_L[7:0]				0x00	R
0x13	ZDATA_H	[7:0]			SX				ZDATA	_H[3:0]		0x00	R
0x14	TEMP_L	[7:0]					TEN	P_L[7:0]				0x00	R
0x15	TEMP_H	[7:0]			SX				TEMP	_H[3:0]		0x00	R
0x16	Reserved	[7:0]					Rese	rved[7:0]				0x00	R
0x17	Reserved	[7:0]					Rese	rved[7:0]				0x00	R
0x1F	SOFT_RESET	[7:0]					SOFT_	RESET[7:0]				0x00	W
0x20	THRESH_ACT_L	[7:0]					THRESH	_ACT_L[7:0]				0x00	RW
0x21	THRESH_ACT_H	[7:0]			UNL	JSED			Th	HRESH_ACT_H[2:0]	0x00	RW
0x22	TIME_ACT	[7:0]					TIME	_ACT[7:0]	•			0x00	RW
0x23	THRESH_INACT_L	[7:0]					THRESH_	INACT_L[7:0]				0x00	RW
0x24	THRESH_INACT_H	[7:0]			UNL	JSED			THI	RESH_INACT_H	I[2:0]	0x00	RW
0x25	TIME_INACT_L	[7:0]					TIME_I	IACT_L[7:0]	•			0x00	RW
0x26	TIME_INACT_H	[7:0]					TIME_IN	IACT_H[7:0]				0x00	RW
0x27	ACT_INACT_CTL	[7:0]		RES		LINKLO	OP	INACT_REF	INACT_EN	ACT_REF	ACT_EN	0x00	RW
0x28	FIFO_CONTROL	[7:0]		U	INUSED			AH	FIFO_TEMP	FIFO_	_MODE	0x00	RW
0x29	FIFO_SAMPLES	[7:0]					FIFO_S/	MPLES[7:0]	•			0x80	RW
0x2A	INTMAP1	[7:0]	INT_LOW	AWAKE	INACT	A	ст	FIFO_OVER- RUN	FIFO_WATER- MARK	FIFO_READY	DATA_READY	0x00	RW
0x2B	INTMAP2	[7:0]	INT_LOW	AWAKE	INACT	A	ст	FIFO_OVER- RUN	FIFO_WATER- MARK	FIFO_READY	DATA_READY	0x00	RW
0x2C	FILTER_CTL	[7:0]	RA	ANGE	RES	H	ALF_BW	EXT_SAMPLE		ODR		0x13	RW
0x2D	POWER_CTL	[7:0]	RES	EXT_CLK		LOW_NO	DISE	WAKEUP	AUTOSLEEP	MEA	SURE	0x00	RW
0x2E	SELF_TEST	[7:0]					UNUSED				ST	0x00	RW

REGISTER DETAILS

This section describes the functions of the ADXL362 registers. The ADXL362 powers up with default register values in the as shown in the Reset column of Table 11 in the Register Map section.

Note that any changes to the registers before the POWER_CTL register (Register 0x00 to Register 0x2C) should be made with the device in standby. If changes are made while the ADXL362 is in measurement mode, they may be effective for only part of a measurement.

DEVICE ID REGISTER

Address: 0x00, Reset: 0xAD, Name: DEVID_AD

This register contains the Analog Devices device ID, 0xAD.

Ē	87	B6	B5	B4	B3	B2	B1	B0
	1	0	1	0	1	1	0	1

DEVICE ID: 0x1D REGISTER

Address: 0x01, Reset: 0x1D, Name: DEVID_MST

This register contains the Analog Devices MEMS device ID, 0x1D.

B7	B6	B5	B4	B3	B2	B1	B0
0	0	0	1	1	1	0	1

PART ID: 0xF2 REGISTER

Address: 0x02, Reset: 0xF2, Name: PARTID

This register contains the device ID, 0xF2 (362 octal).

B7	B6	B5	84	B3	B2	B1	B0
1	1	1	1	0	0	1	0

SILICON REVISION ID REGISTER

Address: 0x03, Reset: 0x01, Name: REVID

This register contains the product revision ID, beginning with 0x01 and incrementing for each subsequent revision.

L	B7	B6	B5	B4	B3	B2	B1	BO
	0	0	0	0	0	0	0	1

X-AXIS DATA (8 MSB) REGISTER

Address: 0x08, Reset: 0x00, Name: XDATA

This register holds the eight most significant bits of the x-axis acceleration data. This limited resolution data register is used in power conscious applications where eight bits of data are sufficient: energy can be conserved by reading only one byte of data per axis, rather than two.

B7	B6	B5	B4	B3	B2	B1	В0	1
0	0	0	0	0	0	0	0	

Y-AXIS DATA (8 MSB) REGISTER

Address: 0x09, Reset: 0x00, Name: YDATA

This register holds the eight most significant bits of the y-axis acceleration data. This limited resolution data register is used in power conscious applications where eight bits of data are sufficient: energy can be conserved by reading only one byte of data per axis, rather than two.

B7	B6	B5	B4	B3	B2	B1	В0	ı
0	0	0	0	0	0	0	0	

Z-AXIS DATA (8 MSB) REGISTER

Address: 0x0A, Reset: 0x00, Name: ZDATA

This register holds the eight most significant bits of the z-axis acceleration data. This limited resolution data register is used in power conscious applications where eight bits of data are sufficient: energy can be conserved by reading only one byte of data per axis, rather than two.

B7	B6	B5	B4	B3	B2	B1	В0
0	0	0	0	0	0	0	0

STATUS REGISTER

Address: 0x0B, Reset: 0x40, Name: STATUS

This register includes the following bits that describe various conditions of the ADXL362.



Table 12. Bit Descriptions for STATUS

Bits	Bit Name	Settings	Description	Reset	Access
7	ERR_USER_REGS		SEU Error Detect. 1 indicates one of two conditions: either an SEU event, such as an alpha particle of a power glitch, has disturbed a user register setting or the ADXL362 is not configured. This bit is high upon both startup and soft reset, and resets as soon as any register write commands are performed.	0x0	R
6	AWAKE		Indicates whether the accelerometer is in an active (AWAKE = 1) or inactive (AWAKE = 0) state, based on the activity and inactivity functionality. To enable autosleep, activity and inactivity detection must be in linked mode or loop mode (LINK/LOOP bits in the ACT_INACT_CTL register); otherwise, this bit defaults to 1 and should be ignored.	0x1	R
5	INACT		Inactivity. 1 indicates that the inactivity detection function has detected an inactivity or a free fall condition.	0x0	R
4	ACT		Activity. 1 indicates that the activity detection function has detected an overthreshold condition.	0x0	R
3	FIFO_OVERRUN		FIFO Overrun. 1 indicates that the FIFO has overrun or overflowed, such that new data replaces unread data. See the Using FIFO Interrupts section for details.	0x0	R
2	FIFO_WATERMARK		FIFO Watermark. 1 indicates that the FIFO contains at least the desired number of samples, as set in the FIFO_SAMPLES register. See the Using FIFO Interrupts section for details.	0x0	R
1	FIFO_READY		FIFO Ready. 1 indicates that there is at least one sample available in the FIFO output buffer. See the Using FIFO Interrupts section for details.	0x0	R
0	DATA_READY		Data Ready. 1 indicates that a new valid sample is available to be read. This bit clears when a FIFO read is performed. See the Data Ready Interrupt section for more details.	0x0	R

FIFO ENTRIES REGISTERS

These registers indicate the number of valid data samples present in the FIFO buffer. This number ranges from 0 to 512 or 0x00 to 0x200. FIFO_ENTRIES_L contains the least significant byte. FIFO_ENTRIES_H contains the two most significant bits. Bits[15:10] of FIFO_ENTRIES_H are unused (represented as X = don't care).

Address: 0x0C, Reset: 0x00, Name: FIFO_ENTRIES_L

L	B7	B6	B5	B4	B3	B2	B1	В0	
	0	0	0	0	0	0	0	LSB	

Address: 0x0D, Reset: 0x00, Name: FIFO_ENTRIES_H

B15	B14	B13	B12	B11	B10	B9	B8
х	х	х	х	х	х	MSB	0

X-AXIS DATA REGISTERS

These two registers contain the sign extended (SX) x-axis acceleration data. XDATA_L contains the eight least significant bits (LSBs), and XDATA_H contains the four most significant bits (MSBs) of the 12-bit value.

The sign extension bits (B[15:12], denoted as SX in the XDATA_H bit map that follows) have the same value as the MSB (B11).

Address: 0x0E, Reset: 0x00, Name: XDATA_L



Address: 0x0F, Reset: 0x00, Name: XDATA_H

B15	B14	B13	B12	B11	B10	B9	B8
SX	SX	SX	SX	MSB	0	0	0

Y-AXIS DATA REGISTERS

These two registers contain the sign extended (SX) y-axis acceleration data. YDATA_L contains the eight LSBs and YDATA_H contains the four MSBs of the 12-bit value.

The sign extension bits (B[15:12], denoted as SX in the YDATA_H bit map that follows) have the same value as the MSB (B11).

Address: 0x10, Reset: 0x00, Name: YDATA_L

B7	B6	B5	В4	B3	B2	B1	BO
0	0	0	0	0	0	0	LSB

Address: 0x11, Reset: 0x00, Name: YDATA_H

B15	B14	B13	B12	B11	B10	B9	B8
SX	SX	SX	SX	MSB	0	0	0

Z-AXIS DATA REGISTERS

These two registers contain the sign extended (SX) z-axis acceleration data. ZDATA_L contains the eight LSBs, and ZDATA_H contains the four MSBs of the 12-bit value.

The sign extension bits (B[15:12], denoted as SX in the ZDATA_H bit map that follows) have the same value as the MSB (B11).

Address: 0x12, Reset: 0x00, Name: ZDATA_L

B7	B6	B5	B4	B3	B2	B1	В0
0	0	0	0	0	0	0	LSB

Address: 0x13, Reset: 0x00, Name: ZDATA_H

B15	B14	B13	B12	B11	B10	B9	B8
SX	SX	SX	SX	MSB	0	0	0

TEMPERATURE DATA REGISTERS

These two registers contain the sign extended (SX) temperature sensor output data. TEMP_L contains the eight LSBs, and TEMP_H contains the four MSBs of the 12-bit value. The value is sign extended; therefore, Bits[B15:B12] of TEMP_H are all 0s or all 1s, based on the value of Bit B11.

The sign extension bits (B[15:12], denoted as SX in the TEMP_H bit map that follows) have the same value as the MSB (B11).

Address: 0x14, Reset: 0x00, Name: TEMP_L

L	B7	B6	B5	В4	B3	B2	B1	В0
	0	0	0	0	0	0	0	LSB

Address: 0x15, Reset: 0x00, Name: TEMP_H

B15	B14	B13	B12	B11	B10	B9	B8
SX	SX	SX	SX	MSB	0	0	0

SOFT RESET REGISTER

Address: 0x1F, Reset: 0x00, Name: SOFT_RESET

Writing Code 0x52 (representing the letter, R, in ASCII or unicode) to this register immediately resets the ADXL362. All register settings are cleared, and the sensor is placed in standby. Interrupt pins are configured to a high output impedance mode and held to a valid state by bus keepers.

This is a write-only register. If read, data in it is always 0x00.

B7 B6	B5	B4	B3	B2	B1	B0
0 0	0	0	0	0	0	0

ACTIVITY THRESHOLD REGISTERS

To detect activity, the ADXL362 compares the absolute value of the 12-bit (signed) acceleration data with the 11-bit (unsigned) THRESH_ACT value. See the Motion Detection section for more information on activity detection.

The term, THRESH_ACT, refers to an 11-bit unsigned value comprising the THRESH_ACT_L register, which holds its eight LSBs; and the THRESH_ACT_H register, which holds its three MSBs.

THRESH_ACT is set in codes; the value in g depends on the measurement range setting that is selected.

THRESH_ACT [*g*] = *THRESH_ACT* [codes]/*Sensitivity* [codes per *g*]

Address: 0x20, Reset: 0x00, Name: THRESH_ACT_L

B7	B6	B5	B4	B3	B2	B1	BO	
0	0	0	0	0	0	0	LSB	

Address: 0x21, Reset: 0x00, Name: THRESH_ACT_H

B15	B14	B13	B12	B11	B10	B9	B8
х	х	х	х	х	MSB	0	0

ACTIVITY TIME REGISTER

Address: 0x22, Reset: 0x00, Name: TIME_ACT

The activity timer implements a robust activity detection that minimizes false positive motion triggers. When the timer is used, only sustained motion can trigger activity detection. Refer to the Fewer False Positives section for additional information.

The value in this register sets the number of consecutive samples that must have at least one axis greater than the activity threshold (set by THRESH_ACT) for an activity event to be detected.

The time (in seconds) is given by the following equation:

Time = TIME_ACT/ODR

where:

TIME_ACT is the value set in this register. *ODR* is the output data rate set in the FILTER_CTL register (Address 0x2C).

Setting the activity time to 0x00 has the same result as setting this time to 0x01: Activity is detected when a single acceleration sample has at least one axis greater than the activity threshold (THRESH_ACT).

When the accelerometer is in wake-up mode, the TIME_ACT value is ignored and activity is detected based on a single acceleration sample.

B7	B6	B5	B4	B3	B2	B1	в0
0	0	0	0	0	0	0	0

INACTIVITY THRESHOLD REGISTERS

To detect inactivity, the absolute value of the 12-bit acceleration data is compared with the 11-bit (unsigned) THRESH_INACT value. See the Motion Detection section for more information.

The term, THRESH_INACT, refers to an 11-bit unsigned value comprised of the THRESH_INACT_L registers, which holds its eight LSBs and the THRESH_INACT_H register, which holds its three MSBs.

This 11-bit unsigned value sets the threshold for inactivity detection. This value is set in codes; the value (in *g*) depends on the measurement range setting selected:

THRESH_INACT [g] = THRESH_INACT [codes]/Sensitivity [codes per g]

Address: 0x23, Reset: 0x00, Name: THRESH_INACT_L

B7	B6	B5	B4	B3	B2	B1	BO
0	0	0	0	0	0	0	LSB

Address: 0x24, Reset: 0x00, Name: THRESH_INACT_H

B15	B14	B13	B12	B11	B10	B9	B8
х	х	х	х	х	MSB	0	0

INACTIVITY TIME REGISTERS

The 16-bit value in these registers sets the number of consecutive samples that must have all axes lower than the inactivity threshold (set by THRESH_INACT) for an inactivity event to be detected.

The TIME_INACT_L register holds the eight LSBs and the TIME_INACT_H register holds the eight MSBs of the 16-bit TIME_INACT value.

The time in seconds can be calculated as

Time = TIME_INACT/ODR

where:

TIME_INACT is the 16-bit value set by the TIME_INACT_L register (eight LSBs) and the TIME_INACT_H register (eight MSBs). *ODR* is the output data rate set in the FILTER_CTL register (Address 0x2C).

The 16-bit value allows for long inactivity detection times. The maximum value is 0xFFFF or 65,535 samples. At the lowest output data rate, 12.5 Hz, this equates to almost 90 minutes. In this configuration, the accelerometer must be stationary for 90 minutes before putting its system to sleep.

Setting the inactivity time to 0x00 has the same result as setting this time to 0x01: Inactivity is detected when a single acceleration sample has all axes lower than the inactivity threshold (THRESH_INACT).

Address: 0x25, Reset: 0x00, Name: TIME_INACT_L

B7	B6	B5	В4	B3	B2	B1	в0
0	0	0	0	0	0	0	LSB

Address: 0x26, Reset: 0x00, Name: TIME_INACT_H

B15	B14	B13	B12	B11	B10	В9	B8
MSB	0	0	0	0	0	0	0

ACTIVITY/INACTIVITY CONTROL REGISTER

Address: 0x27, Reset: 0x00, Name: ACT_INACT_CTL



Table 13. Bit Descriptions for ACT_INACT_CTL

Bits	Bit Name	Settings	Description	Reset	Access
[7:6]	UNUSED		Unused Bits.	0x0	RW
[5:4]	LINK/LOOP	X0	Default Mode.	0x0	RW
			Activity and inactivity detection are both enabled, and their interrupts (if mapped) must be acknowledged by the host processor by reading the STATUS register. Autosleep is disabled in this mode. Use this mode for free fall detection applications.		
		01	Linked Mode.		
			Activity and inactivity detection are linked sequentially such that only one is enabled at a time. Their interrupts (if mapped) must be acknowledged by the host processor by reading the STATUS register.		
		11	Loop Mode.		
			Activity and inactivity detection are linked sequentially such that only one is enabled at a time, and their interrupts are internally acknowledged (do not need to be serviced by the host processor).		
			To use either linked or looped mode, both ACT_EN (Bit 0) and INACT_EN (Bit 2) must be set to 1; otherwise, the default mode is used. For additional information, refer to the Linking Activity and Inactivity Detection section.		
3	INACT_REF		Referenced/Absolute Inactivity Select.	0x0	RW
			1 = inactivity detection function operates in referenced mode.		
			0= inactivity detection function operates in absolute mode.		
2	INACT_EN		Inactivity Enable.	0x0	RW
			1 = enables the inactivity (underthreshold) functionality.		
1	ACT_REF		Referenced/Absolute Activity Select.	0x0	RW
			1 = activity detection function operates in referenced mode.		
			0 = activity detection function operates in absolute mode.		
0	ACT_EN		Activity Enable.	0x0	RW
			1 = enables the activity (overthreshold) functionality.		

FIFO CONTROL REGISTER

Address: 0x28, Reset: 0x00, Name: FIFO_CONTROL



Table 14. Bit Descriptions for FIFO_CONTROL

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	UNUSED		Unused Bits.	0x0	RW
3	AH		Above Half.	0x0	RW
			This bit is the MSB of the FIFO_SAMPLES register, allowing FIFO samples a range of 0 to 511.		
2	FIFO_TEMP		Store Temperature Data to FIFO. $1 =$ temperature data is stored in the FIFO together with x-, y-, and z-axis acceleration data.	0x0	RW
[1:0]	FIFO_MODE		Enable FIFO and Mode Selection.	0x0	RW
		00	FIFO is disabled.		
		01	Oldest saved mode.		
		10	Stream mode.		
		11	Triggered mode.		

FIFO SAMPLES REGISTER

Address: 0x29, Reset: 0x80, Name: FIFO_SAMPLES

The value in this register specifies the number of samples to store in the FIFO. The AH bit in the FIFO_CONTROL register (Address 0x28) is used as the MSB of this value. The full range of FIFO samples is 0 to 511.

The default value of this register is 0x80 to avoid triggering the FIFO watermark interrupt (see the FIFO Watermark section for more information).

L	B7	B6	B5	В4	B3	B2	B1	BO	
	1	0	0	0	0	0	0	0	

The following bit map is duplicated from the FIFO Control Register section to indicate the AH bit.



Address: 0x2A, Reset: 0x00, Name: INTMAP1

INT1/INT2 FUNCTION MAP REGISTERS

The INT1 and INT2 registers configure the INT1/INT2 interrupt pins, respectively. Bits[B6:B0] select which function(s) generate an interrupt on the pin. If its corresponding bit is set to 1, the function generates an interrupt on the INT pin. Bit B7 configures whether the pin operates in active high (B7 low) or active low (B7 high) mode.

Any number of functions can be selected simultaneously for each pin. If multiple functions are selected, their conditions are OR'ed together to determine the INT pin state. The status of each individual function can be determined by reading the STATUS register. If no interrupts are mapped to an INT pin, the pin remains in a high impedance state, held to a valid logic state by a bus keeper.



Table 15. Bit Descriptions for INTMAP1

Bits	Bit Name	Settings	Description	Reset	Access
7	INT_LOW		1 = INT1 pin is active low.	0x0	RW
6	AWAKE		1 = maps the awake status to INT1 pin.	0x0	RW
5	INACT		1 = maps the inactivity status to INT1 pin.	0x0	RW
4	ACT		1 = maps the activity status to INT1 pin.	0x0	RW
3	FIFO_OVERRUN		1 = maps the FIFO overrun status to INT1 pin.	0x0	RW
2	FIFO_WATERMARK		1 = maps the FIFO watermark status to INT1 pin.	0x0	RW
1	FIFO_READY		1 = maps the FIFO ready status to INT1 pin.	0x0	RW
0	DATA_READY		1 = maps the data ready status to INT1 pin.	0x0	RW

Address: 0x2B, Reset: 0x00, Name: INTMAP2



Table 16. Bit Descriptions for INTMAP2

Bits	Bit Name	Settings	Description	Reset	Access
7	INT_LOW		1 = INT2 pin is active low.	0x0	RW
6	AWAKE		1 = maps the awake status to INT2 pin.	0x0	RW
5	INACT		1 = maps the inactivity status to INT2 pin.	0x0	RW
4	ACT		1 = maps the activity status to INT2 pin.	0x0	RW
3	FIFO_OVERRUN		1 = maps the FIFO overrun status to INT2 pin.	0x0	RW
2	FIFO_WATERMARK		1 = maps the FIFO watermark status to INT2 pin.	0x0	RW
1	FIFO_READY		1 = maps the FIFO ready status to INT2 pin.	0x0	RW
0	DATA_READY		1 = maps the data ready status to INT2 pin.	0x0	RW

FILTER CONTROL REGISTER

Address: 0x2C, Reset: 0x13, Name: FILTER_CTL



Table 17. Bit Descriptions	for FILTER_	CTL
----------------------------	-------------	-----

Bits	Bit Name	Settings	Description	Reset	Access
[7:6]	RANGE		Measurement Range Selection.	0x0	RW
		00	$\pm 2 g$ (reset default)		
		01	±4 g		
		1X	±8 g		
5	RES		Reserved.	0x0	RW
4	HALF_BW		Halved Bandwidth. Additional information is provided in the Antialiasing section.	0x1	
			1 = the bandwidth of the antialiasing filters is set to ¼ the output data rate (ODR) for more conservative filtering.		
			0 = the bandwidth of the filters is set to $\frac{1}{2}$ the ODR for a wider bandwidth.		
3	EXT_SAMPLE		External Sampling Trigger. 1 = the INT2 pin is used for external conversion timing control. Refer to the Using Synchronized Data Sampling section for more information.	0x0	RW
[2:0]	ODR		Output Data Rate. Selects ODR and configures internal filters to a bandwidth of ½ or ¼ the selected ODR, depending on the HALF_BW bit setting.	0x3	RW
		000	12.5 Hz		
		001	25 Hz		
		010	50 Hz		
		011	100 Hz (reset default)		
		100	200 Hz		
		101111	400 Hz		

POWER CONTROL REGISTER

Address: 0x2D, Reset: 0x00, Name: POWER_CTL



Table 18. Bit Descriptions for POWER_CTL

Bits	Bit Name	Settings	Description	Reset	Access
7	Reserved		Reserved.	0x0	RW
6	EXT_CLK		External Clock. See the Using an External Clock section for additional details.	0x0	RW
			1 = the accelerometer runs off the external clock provided on the INT1 pin.		
[5:4]	LOW_NOISE		Selects Power vs. Noise Tradeoff:	0x0	RW
		00	Normal operation (reset default).		
		01	Low noise mode.		
		10	Ultralow noise mode.		
		11	Reserved.		
3	WAKEUP		Wake-Up Mode. See the Operating Modes section for a detailed	0x0	RW
			description of wake-up mode.		
			1 = the part operates in wake-up mode.		
2	AUTOSLEEP		Autosleep. Activity and inactivity detection must be in linked mode or loop mode (LINK/LOOP bits in ACT_INACT_CTL register) to enable	0x0	RW
			autosleep; otherwise, the bit is ignored. See the Motion Detection section for details.		
			1 = autosleep is enabled, and the device enters wake-up mode		
			automatically upon detection of inactivity.		
[1:0]	MEASURE		Selects Measurement Mode or Standby.	0x0	RW
		00	Standby.		
		01	Reserved.		
		10	Measurement mode.		
		11	Reserved.		

SELF TEST REGISTER

Address: 0x2E, Reset: 0x00, Name: SELF_TEST

Refer to the Self Test section for information on the operation of the self test feature, and see the Using Self Test section for guidelines on how to use this functionality.



Table 19. Bit Descriptions for SELF_TEST

Name Setting	s Description	Reset	Access
JSED		0x0	RW
	Self Test. 1 = 3 colf test force is applied to the x- y- and z-aves	0x0	RW
	j	SED	SED 0x0 Self Test. 0x0

APPLICATIONS INFORMATION

APPLICATION EXAMPLES

This section includes a few application circuits, highlighting useful features of the ADXL362.

Device Configuration

This section outlines the procedure for configuring the device and acquiring data. In general, the procedure follows the sequence of the register map, starting with Register 0x20, THRESH_ACT_L.

- 1. Set activity and inactivity thresholds and timers.
 - a. Write to Register 0x20 to Register 0x26.
 - b. To minimize false positive motion triggers, set the TIME_ACT register greater than 1.
- 2. Configure activity and inactivity functions.
 - a. Write to Register 0x27.
- 3. Configure FIFO.
 - a. Write to Register 0x28 and Register 0x29.
- 4. Map interrupts.
 - a. Write to Register 0x2A and Register 0x2B.
- Configure general device settings.
 a. Write to Register 0x2C.
- Turn measurement on.
 - a. Write to Register 0x2D.

Settings for each of the registers vary based on application requirements. For more information, see the Register Details section.

Autonomous Motion Switch

The features of the ADXL362 make it ideal for use as an autonomous motion switch. The example outlined here implements a switch that, once configured, operates without the intervention of a host processor to intelligently manage system power. In this example, the awake signal, mapped to the INT2 pin, drives a high-side power switch, such as the ADP195, to control power to the downstream circuitry.



Figure 43. Awake Signal to Control Power to Downstream Circuitry

Startup Routine

This routine assumes a $\pm 2 g$ measurement range and operation in wake-up mode.

- 1. Write 250 decimal (0xFA) to Register 0x20, and write 0 to Register 0x21: sets activity threshold to 250 mg.
- 2. Write 150 decimal (0x96) to Register 0x23, and write 0 to Register 0x24: sets inactivity threshold to 150 mg.
- 3. Write 30 decimal (0x1E) to Register 0x25: sets inactivity timer to 30 samples or about 5 seconds.
- 4. Write 0x3F to Register 0x27: configures motion detection in loop mode and enables referenced activity and inactivity detection.
- 5. Write 0x40 to Register 0x2B: map the AWAKE bit to INT2. The INT2 pin is tied to the gate of the switch.
- 6. Write 0x0A to Register 0x2D: begins the measurement in wake-up mode.

Using External Timing Triggers

Figure 44 shows an application diagram for using the INT1 pin as the input for an external clock. In this mode, the external clock determines all accelerometer timing, including the output data rate and bandwidth.

To enable this feature, at the end of the desired start-up routine, set Bit 6 in the POWER_CTL register; for example, write 0x42 to this register to enable the use of an external clock and place the accelerometer into measurement mode.



Figure 44. INT1 Pin as the Input for the External Clock

Figure 45 is an application diagram for using the INT2 pin as a trigger for synchronized sampling. Acceleration samples are produced every time this trigger is activated. To enable this feature, near the end of the desired start-up routine, set Bit 3 in the FILTER_CTL register; for example, write 0x4B to this register to enable the trigger and configure the accelerometer for $\pm 8 g$ measurement range and 100 Hz ODR.



Figure 45. Using the INT2 Pin to Trigger Synchronized Sampling

Data Sheet

Example: Implementing Free Fall Detection

Many digital output accelerometers include a built-in free fall detection feature. In the ADXL362, implement this function using the inactivity interrupt.

When an object is in true free fall, acceleration on all axes is 0 g. Thus, free fall detection is achieved by looking for acceleration on all axes to fall below a certain threshold (close to 0 g) for a certain amount of time. The inactivity detection functionality, when used in absolute mode, does exactly this.

To use inactivity to implement free fall detection, set the value in THRESH_INACT to the desired free fall threshold. Values between 300 mg and 600 mg are recommended; the register setting for these values varies based on the g range setting of the device, as follows:

THRESH_INACT = *Threshold Value* [g] × *Scale Factor* [LSB per g]

Set the value in TIME_INACT to implement the minimum amount of time that the acceleration on all axes must be less than the free fall threshold to generate a free fall condition. Values between 100 ms and 350 ms are recommended; the register setting for this varies based on the output data rate.

TIME_INACT = Time [sec] × *Data Rate* [Hz]

When a free fall condition is detected, the inactivity status is set to 1 and, if the function is mapped to an interrupt pin, an inactivity interrupt triggers on that pin.

Startup Routine

The following startup routine configures the ADXL362 for a typical free fall application. This routine assumes a $\pm 8 g$ measurement range and 100 Hz output data rate. Thresholds and timing values can be modified to suit particular application needs.

- 1. Write 0x96 (150 codes) to Register 0x23: sets free fall threshold to 600 mg.
- 2. Write 0x03 to Register 0x25: sets free fall time to 30 ms.
- 3. Write 0x0C to Register 0x27: enables absolute inactivity detection.
- 4. Write 0x20 to Register 0x2A or Register 0x2B to map the inactivity interrupt to INT1 or INT2, respectively.
- 5. Write 0x83 to Register 0x2C: configures the accelerometer to ±8 g range, 100 Hz ODR (output data rate).
- 6. Write 0x02 to Register 0x2D to begin measurement.

Implementation of a complete fall detection application is described in the AN-1023 Application Note, *Fall Detection Application by Using 3-Axis Accelerometer ADXL345*.

POWER

Power Supply Decoupling

Figure 46 shows the recommended bypass capacitors for use with the ADXL362.



Figure 46. Recommended Bypass Capacitors

A 0.1 μ F ceramic capacitor (C_s) at V_s and a 0.1 μ F ceramic capacitor (C_{IO}) at V_{DD I/O} placed as close as possible to the ADXL362. Supply pins are recommended to adequately decouple the accelerometer from noise on the power supply. It is also recommended that V_s and V_{DD I/O} be separate supplies to minimize digital clocking noise on the V_s supply. If this is not possible, additional filtering of the supplies may be necessary.

If additional decoupling is necessary, place a resistor or ferrite bead, no larger than 100 Ω , in series with Vs. Additionally, increasing the bypass capacitance on Vs to a 1 μF tantalum capacitor in parallel with a 0.1 μF ceramic capacitor may also improve noise.

Ensure that the connection from the ADXL362 ground to the power supply ground has low impedance because noise transmitted through ground has an effect similar to noise transmitted through V_s.

Power Supply Requirements

The ADXL362 is designed to operate using supply voltage rails ranging from 1.8 V to 3.3 V. The operating voltage range (V_s), specified in Table 1, ranges from 1.6 V to 3.5 V to account for inaccuracies and transients of up to $\pm 10\%$ on the supply voltage.

The ADXL362 does not require any particular startup transient characteristics, except that it must always be started up from 0 V. When the device is in operation, any time power is removed from the ADXL362, or falls below the operating voltage range, the supplies (V_s, V_{DD I/O}, and any bypass capacitors) must be discharged completely before power is reapplied. To enable supply discharge, it is recommended to power the device from a microcontroller GPIO, connect a shutdown discharge switch to the supply (Figure 47), or use a voltage regulator with a shutdown discharge feature, such as the ADP160.



NOTES

1. THE ADXL362 SUPPLIES MUST BE DISCHARGED FULLY EACH TIME THE VOLTAGE ON THEM DROPS BELOW THE SPECIFIED OPERATING RANGE. A SHUTDOWN SWITCH IS ONE WAY TO DISCHARGE THE SUPPLIES.

Figure 47. Using a Switch to Discharge the ADXL362 Supplies

FIFO MODES

The FIFO is a 512-sample memory buffer that can be used to save power, unburden the host processor, and autonomously record data.

The 512 FIFO samples can be allotted as either:

- 170 sample sets of concurrent 3-axis data; or
- 128 sample sets of concurrent 3-axis and temperature data

The FIFO operates in one of the four modes described in this section.

FIFO Disabled

When the FIFO is disabled, no data is stored in it and any data already stored in it is cleared.

The FIFO is disabled by setting the FIFO_MODE bits in the FIFO_CONTROL register (Address 0x28) to Binary Value 0b00.

Oldest Saved Mode

In oldest saved mode, the FIFO accumulates data until it is full and then stops. Additional data is collected only when space is made available by reading samples out of the FIFO buffer. (This mode of operation is sometimes referred to as "First N.")

The FIFO is placed into oldest saved mode by setting the FIFO_MODE bits in the FIFO_CONTROL register (Address 0x28) to Binary Value 0b01.

Stream Mode

In stream mode, the FIFO always contains the most recent data. The oldest sample is discarded when space is needed to make room for a newer sample. (This mode of operation is sometimes referred to as "Last N.")

Stream mode is useful for unburdening a host processor. The processor can tend to other tasks while data is being collected in the FIFO. When the FIFO fills to a certain number of samples (specified by the FIFO_SAMPLES register along with the AH bit in the FIFO_CONTROL register), it triggers a FIFO watermark interrupt (if this interrupt is enabled). At this point, the host processor can read the contents of the entire FIFO and then return to its other tasks as the FIFO fills again.

The FIFO is placed into stream mode by setting the FIFO_MODE bits in the FIFO_CONTROL register (Address 0x28) to Binary Value 0b10.

Triggered Mode

In triggered mode, the FIFO saves samples surrounding an activity detection event. The operation is similar to a one-time run trigger on an oscilloscope. The number of samples to be saved prior to the activity event is specified in FIFO_SAMPLES (Register 0x29, along with the AH bit in the FIFO_CONTROL register, Address 0x28).

Place the FIFO into triggered mode by setting the FIFO_MODE bits in the FIFO_CONTROL register (Address 0x28) to Binary Value 0b11.

FIFO Configuration

The FIFO is configured via Register 0x28 and Register 0x29. Settings are described in detail in the FIFO Control Register section.

FIFO Interrupts

The FIFO can generate interrupts to indicate when samples are available, when a specified number of samples has been collected, and when the FIFO overflows and samples are lost. See the Using FIFO Interrupts section for more information.

Retrieving Data from FIFO

FIFO data is read by issuing a FIFO read command, described in the SPI Commands section. Data is formatted as a 16-bit value as represented in Table 20.

When reading data, the least significant byte (Bits[B7:B0]) is read first, followed by the most significant byte (Bits[B15:B8]). Bits[B11:B0] represent the 12-bit, twos complement acceleration or temperature data. Bits[B13:B12] are sign extension bits, and Bits[B15:B14] indicate the type of data, as listed in Table 20.

Table 20. FIFO Buffer Data Format

B15	B14	B13	B12	B11	B10	B9	B8
Data Type:		Sign		MSB		Data	
00: X-Axis		Exter	nsion				
01: Y-Axis							
10: Z-Axis							
11: Temp							

B7	B6	B5	B4	B3	B2	B1	B0
	Data						LSB

Because the data format is 16-bit, the data must be read from the FIFO two bytes at a time. When a multibyte read is performed, the number of bytes read should always be an even number. Multibyte reads of FIFO data can be performed with no limit on the number of bytes read. If additional bytes are read after the FIFO is empty, the data in the additional bytes are read as 0x00.

As each sample set is acquired, it is written into the FIFO in the following order:

- X-axis
- Y-axis
- Z-axis
- Temperature (optional)

This pattern repeats until the FIFO is full, at which point the behavior depends on the FIFO mode (see the FIFO section). If the FIFO has insufficient space for four data entries (or three entries if temperature is not being stored), then an incomplete sample set can be stored.

Data Sheet

FIFO data is output on a per datum basis. As each data item is read, the same amount of space is freed up in the stack. Again, this can lead to incomplete sample sets being present in the FIFO.

For additional system level FIFO applications, refer to the AN-1025 Application Note, Utilization of the First In, First Out (FIFO) Buffer in Analog Devices, Inc. Digital Accelerometers.

INTERRUPTS

Several of the built-in functions of the ADXL362 can trigger interrupts to alert the host processor of certain status conditions. This section describes the functionality of these interrupts.

Interrupt Pins

Interrupts can be mapped to either (or both) of two designated output pins, INT1 and INT2, by setting the appropriate bits in the INTMAP1 and INTMAP2 registers, respectively. All functions can be used simultaneously. If multiple interrupts are mapped to one pin, the OR combination of the interrupts determines the status of the pin.

If no functions are mapped to an interrupt pin, that pin is automatically configured to a high impedance (high-Z) state. The pins are also placed in the high-Z state upon a reset.

When a certain status condition is detected, the pin that condition is mapped to is activated. The configuration of the pin is active high by default so that when it is activated, the pin goes high. However, this configuration can be switched to

Table 21. Interrupt Pin Digital Output

active low by setting the INT_LOW bit in the appropriate INTMAPx register.

The INT pins can be connected to the interrupt input of a host processor where interrupts are responded to with an interrupt routine. Because multiple functions can be mapped to the same pin, the STATUS register can be used to determine which condition caused the interrupt to trigger.

Clear interrupts in one of several ways, as follows:

- Reading the STATUS register (Address 0x0B) clears activity and inactivity interrupts.
- Reading from the data registers. Address 0x08 to Address 0x0A or Address 0x0E to Address 0x15 clears the data ready interrupt.
- Reading enough data from the FIFO buffer so that interrupt conditions are no longer met clears the FIFO ready, FIFO watermark, and FIFO overrun interrupts.

Both interrupt pins are push-pull low impedance pins with an output impedance of about 500 Ω (typical) and digital output specifications, as shown in Table 21. Both pins have bus keepers that hold them to a valid logic state when they are in a high impedance mode.

To prevent interrupts from being falsely triggered during configuration, disable interrupts while their settings, such as thresholds, timings, or other values, are configured.

			Limit ¹		
Parameter	Test Conditions	Min	Max	Unit	
Digital Output					
Low Level Output Voltage (V _{OL})	I _{OL} = 500 μA I _{OH} = -300 μA		$0.2 imes V_{\text{DD I/O}}$	V	
High Level Output Voltage (V _{он})	I _{OH} = −300 μA	$0.8 imes V_{DD I/O}$		V	
Low Level Output Current (I _{OL})	$V_{OL} = V_{OL, max}$	500		μA	
High Level Output Current (I _{OH})	$V_{OH} = V_{OH, min}$		-300	μA	

¹ Limits based on design, not production tested.

Alternate Functions of Interrupt Pins

The INT1 and INT2 pins can be configured for use as input pins instead of for signaling interrupts. INT1 is used as an external clock input when the EXT_CLK bit (Bit 6) in the POWER_CTL register (Address 0x2D) is set. INT2 is used as the trigger input for synchronized sampling when the EXT_SAMPLE bit (Bit 3) in the FILTER_CTL register (Address 0x2C) is set. One or both of these alternate functions can be used concurrently; however, if an interrupt pin is used for its alternate function, it cannot simultaneously be used for its primary function, to signal interrupts.

External clocking and data synchronization are described in the Applications Information section.

Activity and Inactivity Interrupts

The ACT bit (Bit 4) and INACT bit (Bit 5) in the STATUS register are set when activity and inactivity are detected, respectively. Detection procedures and criteria are described in the Motion Detection section.

Data Ready Interrupt

The DATA_READY bit (Bit 0) is set when new valid data is available, and it is cleared when no new data is available.

The DATA_READY bit is not set while any of the data registers, Address 0x08 to Address 0x0A and Address 0x0E to Address 0x15, are being read. If DATA_READY = 0 prior to a register read and new data becomes available during the register read, DATA_READY remains at 0 until the read is complete and, only then, is set to 1.

If DATA_READY = 1 prior to a register read, it is cleared at the start of the register read.

If DATA_READY = 1 prior to a register read and new data becomes available during the register read, DATA_READY is cleared to 0 at the start of the register read and remains at 0 throughout the read. When the read is complete, DATA_READY is set to 1.

Using FIFO Interrupts

FIFO Watermark

The FIFO_WATERMARK bit (Bit 2) is set when the number of samples stored in the FIFO is equal to or exceeds the number specified in the FIFO_SAMPLES register (Address 0x29) together with the AH bit in the FIFO_CONTROL register (Bit 3, Address 0x28). The FIFO_WATERMARK bit is cleared automatically when enough samples are read from the FIFO, such that the number of samples remaining is lower than that specified.

If the number of FIFO samples is set to 0, the FIFO watermark interrupt is set. To avoid unexpectedly triggering this interrupt, the default value of the FIFO_SAMPLES register is 0x80.

FIFO Ready

The FIFO_READY bit (Bit 1) is set when there is at least one valid sample available in the FIFO output buffer. This bit is cleared when no valid data is available in the FIFO.

Overrun

The FIFO_OVERRUN bit (Bit 3) is set when the FIFO has overrun or overflowed, such that new data replaces unread data. This may indicate a full FIFO that has not yet been emptied or a clocking error caused by a slow SPI transaction. If the FIFO is configured to oldest saved mode, an overrun event indicates that there is insufficient space available for a new sample.

The FIFO_OVERRUN bit is cleared automatically when the contents of the FIFO are read. Likewise, when the FIFO is disabled, the FIFO_OVERRUN bit is cleared.

USING SYNCHRONIZED DATA SAMPLING

For applications that require a precisely timed acceleration measurement, the ADXL362 features an option to synchronize acceleration sampling to an external trigger. The EXT_SAMPLE bit (Bit 3) in the FILTER_CTL Register (Address 0x2C) enables this feature. When the EXT_SAMPLE bit is set to 1, the INT2 pin is automatically reconfigured for use as the sync trigger input.

When external triggering is enabled, it is up to the system designer to ensure that the sampling frequency meets system requirements. Sampling too infrequently causes aliasing. Noise can be lowered by oversampling; however, sampling at too high a frequency may not allow enough time for the accelerometer to process the acceleration data and convert it to valid digital output.

When Nyquist criteria are met, signal integrity is maintained. An internal antialiasing filter is available in the ADXL362 and can assist the system designer in maintaining signal integrity. To prevent aliasing, set the filter bandwidth to a frequency no greater than ½ the sampling rate. For example, when sampling at 100 Hz, set the filter pole to no higher than 50 Hz. The filter pole is set via the ODR bits in the FILTER_CTL register (Address 0x2C). The filter bandwidth is set to ½ the ODR and is set via these bits. Even though the ODR is ignored (as the data rate is set by the external trigger), the filter is still applied at the specified bandwidth.

Because of internal timing requirements, the trigger signal applied to pin INT2 must meet the following criteria:

- The trigger signal is active high.
- The pulse width of the trigger signal must be at least 25 µs.
- The trigger must be deasserted for at least 25 μs before it is reasserted.
- The maximum sampling frequency that is supported is 625 Hz (typical).
- The minimum sampling frequency is set only by system requirements. Samples need not be polled at any minimum rate; however, if samples are polled at a rate lower than the bandwidth set by the antialiasing filter, then aliasing may occur.

USING AN EXTERNAL CLOCK

The ADXL362 has a built-in clock that, by default, is used for clocked internal operations. If desired, an external clock can be provided and used.

To use an external clock, the EXT_CLK bit (Bit 6) in the POWER_CTL register (Address 0x2D) must be set. Setting this bit reconfigures the INT1 pin to an input pin on which the clock can be provided. The external clock must operate at or below 51.2 kHz. Further information is provided in the External Clock section.

USING SELF TEST

The self test function, described in the Self Test section, is enabled via the ST bit in the SELF_TEST register, Address 0x2E. The recommended procedure for using the self test functionality is as follows:

- 1. Read acceleration data for the x-, y-, and z-axes.
- 2. Assert self test by setting the ST bit in the SELF_TEST register, Address 0x2E.
- 3. Wait 1/ODR for the output to settle to its new value.
- 4. Read acceleration data for the x-, y-, and z-axes.
- 5. Compare to the values from Step 1, and convert the difference from LSB to *mg* by multiplying by the sensitivity. If the observed difference falls within the self test output change specification listed in Table 1, then the device passes self test and is deemed operational.
- 6. Deassert self test by clearing the ST bit in the SELF_TEST register, Address 0x2E.

The self test output change specification is given for $V_S = 2.0$ V. Because the electrostatic force is proportional to V_S^2 and the sensitivity of the device is ratiometric to V_S , the output change varies with V_S . The scale factors shown in Table 22 can be used to adjust the expected self test output limits for different supply voltages, V_S .

Note that at higher voltages, self test deltas may exceed 1 g. If the measurement is performed with one axis experiencing 1 g due to gravity, and if the accelerometer is configured for a ± 2 g measurement range, the axis that is aligned with the field of gravity may reach 2 g and its output clips (saturates to its fullscale value). To alleviate this, self test can be measured with the y-axis aligned with gravity (where the y-axis self test output change is negative), or with the accelerometer configured for a ± 4 g or ± 8 g measurement range.

Table 22. Self Test Output Scale Factors for Different Supply Voltages, $V_{\rm S}$

Supply Voltage, Vs (V)	Self Test Output Scale Factor
1.6	0.62
2.0	1.0
2.5	1.6
3.0	2.4
3.5	3.4

OPERATION AT VOLTAGES OTHER THAN 2.0 V

The ADXL362 is tested and specified at a supply voltage of $V_s = 2.0 \text{ V}$; however, it can be powered with a V_s as high as 3.3 V nominal (3.5 V maximum) or as low as 1.8 V nominal (1.6 V minimum). Some performance parameters change as the supply voltage changes, including the supply current (see Figure 30), noise (see Table 7 and Table 8), offset, sensitivity, and self test output change (see Table 22).

Figure 48 shows the potential effect on 0 *g* offset at varying supply voltage. Data for this figure was calibrated to show 0 mg offset at 2.0 V.





MECHANICAL CONSIDERATIONS FOR MOUNTING

Mount the ADXL362 on the printed circuit board (PCB) in a location close to a hard mounting point of the PCB to the case. Mounting the ADXL362 at an unsupported PCB location, as shown in Figure 49, can result in large, apparent measurement errors due to undampened PCB vibration. Locating the accelerometer near a hard mounting point ensures that any PCB vibration at the accelerometer is above the mechanical sensor resonant frequency of the accelerometer and, therefore, effectively invisible to the accelerometer. Multiple mounting points, close to the sensor, and/or a thicker PCB also help to reduce the effect of system resonance on the performance of the sensor.



AXES OF ACCELERATION SENSITIVITY







Figure 51. Output Response vs. Orientation to Gravity

LAYOUT AND DESIGN RECOMMENDATIONS

Figure 52 shows the recommended PCB land pattern.



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OUTLINE DIMENSIONS



Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Quantity	
ADXL362BCCZ-RL	-40°C to +85°C	16-Terminal Land Grid Array [LGA]	CC-16-4	5,000	
ADXL362BCCZ-RL7	-40°C to +85°C	16-Terminal Land Grid Array [LGA]	CC-16-4	1,500	
ADXL362BCCZ-R2	-40°C to +85°C	16-Terminal Land Grid Array [LGA]	CC-16-4	250	
EVAL-ADXL362Z	-40°C to +85°C	Breakout Board			
EVAL-ADXL362Z-DB	-40°C to +85°C	Datalogger and Development Board			
EVAL-ADXL362Z-MLP	-40°C to +85°C	Low Power Real-Time Evaluation System			
EVAL-ADXL362Z-S	-40°C to +85°C	Satellite Board for Evaluation System			

 1 Z = RoHS Compliant Part.

NOTES



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